## FEATURES

- Current Limit using Lower MOSFET Sensing
- Using the 6 V internal regulator for charge pump circuit allows single supply operation up to 18 V
- Programmable Switching Frequency up to 400 KHz
- Soft-Start Function
- 0.8V Precision Reference Voltage Available
- Uncommitted Error Amplifier Available for DDR Voltage Tracking Applications
- Stable with Ceramic Capacitor


## APPLICATIONS

- DDR Memory $V_{D d a} / V_{T T}$ Applications
- Graphic Card
- Hard Disk Drive
- Netcom on-board DC to DC regulator application
- Output voltage as low as 0.8 V
- Low Cost On-Board DC to DC


## SYNCHRONOUS PWM CONTROLLER WITH OVER CURRENT PROTECTION

## ABSOLUTE MAXIMUM RATINGS

Vcc Supply Voltage -0.5V To 25 V
Vc Supply Voltage -0.5V To 25 V
Storage Temperature Range $-65^{\circ} \mathrm{C}$ To $150^{\circ} \mathrm{C}$
Operating Junction Temperature Range $0^{\circ} \mathrm{C}$ To $125^{\circ} \mathrm{C}$
CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device.
PACKAGE INFORMATION


## ELECTRICAL SPECIFICATIONS

Unless otherwise specified, specifications apply over $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{Vc}=12 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=0-70^{\circ} \mathrm{C}$. Typical values refer to $25^{\circ} \mathrm{C}$. Low duty cycle pulse testing is used which keeps junction and case temperatures equal to the ambient temp.

| PARAMETER | SYM | TEST CONDITION | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Feedback Voltage Fb Voltage Initial Accuracy | $V_{\text {FB }}$ |  | 0.784 | 0.800 | 0.816 | V |
| Fb Voltage Line Regulation | Lreg | $4.75 \mathrm{~V}<\mathrm{Vcc}<20 \mathrm{~V}$ |  | 0.3 |  | \% |
| Reference Voltage <br> Ref Voltage Initial Accuracy | $V_{\text {ref }}$ |  | 0.784 | 0.8 | 0.816 | V |
| Drive Current | IReF | Note 1 |  | 2 |  | $\mu \mathrm{A}$ |
| UVLO <br> UVLO Threshold - Vcc | UVLO Vcc | Supply Ramping Up |  | 4.4 |  | V |
| UVLO Hysteresis - Vcc |  |  |  | 0.26 |  | V |
| UVLO Threshold - Vc | UVLO Vc | Supply Ramping Up |  | 3.47 |  | V |
| UVLO Hysteresis - Vc |  |  |  | 0.20 |  | V |
| UVLO Threshold - Fb | UVLO Fb | Fb Ramping Down | 0.3 | 0.4 | 0.5 | V |
| Supply Current <br> Vcc Dynamic Supply Current | Dyn Icc | Freq=200KHz, CL=1500pF |  | 7 | 15 | mA |
| Vc Dynamic Supply Current | Dyn lc | Freq=200KHz, CL=1500pF |  | 7 | 9 | mA |
| Vcc Static Supply Current | Icco | SS=0V |  | 5 | 9 | mA |
| Vc Static Supply Current | IcQ | SS=0V |  | 3 | 4 | mA |

International
IsR Rectifier
IRU3039

| PARAMETER | SYM | TEST CONDITION | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Error Amp <br> Fb Voltage Input Bias Current | IFB1 | SS=3V | -1 | +0.08 | +1 | $\mu \mathrm{A}$ |
| Fb Voltage Input Bias Current | IFB2 | SS=0V | 30 | 55 | 70 | $\mu \mathrm{A}$ |
| Transconductance |  |  |  | 700 |  | $\mu \mathrm{mho}$ |
| VP Voltage Range | $V_{P}$ | Note 1 | 0.8 |  | 1.5 | V |
| Soft-Start Section Charge Current | SS lb | SS=0V | 14 | 22 | 35 | $\mu \mathrm{A}$ |
| Oscillator Section Frequency | Freq | $\begin{array}{\|l\|} \hline \mathrm{Rt}=\text { Open } \\ \mathrm{Rt}=\mathrm{Gnd} \end{array}$ |  | $\begin{aligned} & 200 \\ & 400 \end{aligned}$ |  | KHz |
| Ramp Amplitude | Vramp | Note 1 |  | 1.25 |  | VPP |
| Output Drivers <br> Lo Drive Rise Time | Tr(LO) | CLOAD $=1500 \mathrm{pF}$, Vcc=12V |  | 40 | 100 | ns |
| Hi Drive Rise Time | $\mathrm{Tr}_{( }(\mathrm{H})$ | CLoad $=1500 \mathrm{pF}$, V $\mathrm{Cc}=12 \mathrm{~V}$ |  | 40 | 100 | ns |
| Lo Drive Fall Time | Tf(L) | Cload $=1500 \mathrm{pF}$ |  | 40 | 100 | ns |
| Hi Drive Fall Time | Tf(H) | CLOAD=1500pF |  | 40 | 100 | ns |
| Dead Band Time | TDB | HDrv going Hi or Low |  | 100 |  | ns |
| Max Duty Cycle | Dmax | $\mathrm{Fb}=0.6 \mathrm{~V}$, Freq $=200 \mathrm{KHz}$ |  | 88 |  | \% |
| Min Duty Cycle | Dmin | $\mathrm{Fb}=1.0 \mathrm{~V}$ |  |  | 0 | \% |
| Internal Regulator Output Voltage | Vout2 | $\mathrm{Vcc}=12 \mathrm{~V}$ | 5.7 | 6 | 6.3 | V |
| Drive Current | lout2 |  | 40 | 65 |  | mA |
| Current Limit <br> OC Threshold Set Current | locset |  | 21 | 28 | 35 | $\mu \mathrm{A}$ |
| OC Comp Off-Set Voltage | Voc(OFFSET) |  | -2 | 1.5 | 5 | mV |

Note 1: Guaranteed by design but not tested for production.

## PIN DESCRIPTIONS

| PIN\# | PIN SYMBOL | PIN DESCRIPTION |
| :---: | :---: | :--- |
| 1 | V REF | Reference Voltage. This pin can source current about 2 $\mu \mathrm{A}$. |
| 4 | Vcc | This pin provides biasing for the internal blocks of the IC as well as power for the low side <br> FET driver. A minimum of $1 \mu \mathrm{~F}$, high frequency capacitor must be connected from this pin <br> to ground to provide peak drive current capability. |
| 6 | LDrv | Output driver for the synchronous power MOSFET. |
| 7 | PGnd | This pin serves as the separate ground for MOSFET's driver and should be connected to <br> system's ground plane. |
| 8 | Gnd | This pin serves as analog ground for internal reference and control circuitry. A high fre- <br> quency capacitor must be connected from Vcc pin to this pin for noise free operation. |
| 9 | HDrv | Output driver for the high side power MOSFET. This pin should not go negative (below <br> ground), this may cause problem for the gate drive circuit. It can happen when the inductor <br> current goes negative (Source/Sink), soft-start at no load and for the fast load transient |
| 10 | Vc | from full load to no load. To prevent negative voltage at gate drive, a low forward voltage <br> drop diode might be connected between this pin and ground. |
| 12 | This pin is connected to a voltage that must be at least 4V higher than the bus voltage of <br> the switcher (assuming 5V threshold MOSFET) and powers the high side output driver. A |  |
| minimum of 1 $\mu \mathrm{F}$, high frequency capacitor must be connected from this pin to ground to |  |  |
| provide peak drive current capability. |  |  |

## PIN DESCRIPTIONS

| PIN\# | PIN SYMBOL | PIN DESCRIPTION |
| :---: | :---: | :--- |
| 15 | VouT2 | Output of internal regulator. The output is protected for short circuit. A high frequency <br> capacitor is recommended to be connected from this pin to ground. |
| 16 | OCSet | This pin is connected to the Drain of the lower MOSFET via an external resister and it <br> provides the positive sensing for the internal current sensing circuitry. The external resis- <br> tor programs the current limit threshold depending on the Rosoon) of the power MOSFET. <br> An external capacitor can be placed in parallel with the programming resistor to provide <br> high frequency noise filtering. |
| 17 | SS / $\overline{\text { SD }}$ | This pin provides soft-start for the switching regulator. An internal current source charges <br> an external capacitor that is connected from this pin to ground which ramps up the output <br> of the switching regulator, preventing it from overshooting as well as limiting the input <br> current. The converter can be shutdown by pulling this pin down below 0.4V. |
| 18 | Comp | Compensation pin of the error amplifier. An external resistor and capacitor network is <br> typically connected from this pin to ground to provide loop compensation. |
| 19 | Fb | This pin is connected directly to the output of the switching regulator via resistor divider to <br> provide feedback to the Error amplifier. |
| 20 | VP | Non-inverting input of error amplifier. |
| $2,3,5$, | NC | No connection. |
| $11,3,14$ |  |  |

## BLOCK DIAGRAM



Figure 2 - Simplified block diagram of the IRU3039.

## THEORY OF OPERATION

## Introduction

The IRU3039 is a fixed frequency, voltage mode synchronous controller and consists of a precision reference voltage, an uncommitted error amplifier, an internal oscillator, a PWM comparator, an internal regulator, a comparator for current limit, gate drivers, soft-start and shutdown circuits (see Block Diagram).

The output voltage of the synchronous converter is set and controlled by the output of the error amplifier; this is the amplified error signal from the sensed output voltage and the voltage on non-inverting input of error amplifier $\left(\mathrm{V}_{\mathrm{P}}\right)$. This voltage is compared to a fixed frequency linear sawtooth ramp and generates fixed frequency pulses of variable duty-cycle, which drives the two N-channel external MOSFETs.

The timing of the IC is provided through an internal oscillator circuit which uses on-chip capacitor. The oscillation frequency is programmable between 200 KHz to 400 KHz by using an external resistor. Figure 14 shows switching frequency vs. external resistor (Rt).

## Soft-Start

The IRU3039 has a programmable soft-start to control the output voltage rise and limit the current surge at the start-up. To ensure correct start-up, the soft-start sequence initiates when the Vc and Vcc rise above their threshold ( 3.4 V and 4.4 V respectively) and generates the Power On Reset (POR) signal. Soft-start function operates by sourcing an internal current to charge an external capacitor to about 3 V . Initially, the soft-start function clamps the E/A's output of the PWM converter and disables the short circuit protection. During the power up, the output starts at zero and voltage at Fb is below 0.4 V . The feedback UVLO is disabled during this time by injecting a current $(64 \mu \mathrm{~A})$ into the Fb . This generates a voltage about $1.6 \mathrm{~V}(64 \mu \mathrm{~A} \times 25 \mathrm{~K})$ across the negative input of $\mathrm{E} / \mathrm{A}$ and positive input of the feedback UVLO comparator (see Figure 3).


Figure 3 - Soft-start circuit for IRU3039.
The magnitude of this current is inversely proportional to the voltage at soft-start pin.

The $20 \mu \mathrm{~A}$ current source starts to charge up the external capacitor. In the mean time, the soft-start voltage ramps up, the current flowing into Fb pin starts to decrease linearly and so does the voltage at the positive pin of feedback UVLO comparator and the voltage negative input of $E / A$.

When the soft-start capacitor is around 1 V , the current flowing into the Fb pin is approximately $32 \mu \mathrm{~A}$. The voltage at the positive input of the $\mathrm{E} / \mathrm{A}$ is approximately:

$$
32 \mu \mathrm{~A} \times 25 \mathrm{~K}=0.8 \mathrm{~V}
$$

The E/A will start to operate and the output voltage starts to increase. As the soft-start capacitor voltage continues to go up, the current flowing into the Fb pin will keep decreasing. Because the voltage at pin of $E / A$ is regulated to reference voltage 0.8 V , the voltage at the Fb is:

$$
\left.V_{F B}=0.8-25 \mathrm{~K} \times \text { (Injected Current }\right)
$$

The feedback voltage increases linearly as the injecting current goes down. The injecting current drops to zero when soft-start voltage is around 2 V and the output voltage goes into steady state.

As shown in Figure 4, the positive pin of feedback UVLO comparator is always higher than 0.4 V , therefore, feedback UVLO is not functional during soft-start.


Figure 4 - Theoretical operational waveforms during soft-start.
the output start-up time is the time period when softstart capacitor voltage increases from 1 V to 2 V . The startup time will be dependent on the size of the external soft-start capacitor. The start-up time can be estimated by:

$$
20 \mu \mathrm{~A} \times \mathrm{Tstart}^{2} / \mathrm{Css}=2 \mathrm{~V}-1 \mathrm{~V}
$$

For a given start up time, the soft-start capacitor can be estimated as:

$$
\mathrm{Css} \cong 20 \mu \mathrm{~A} \times \mathrm{Tstart} / 1 \mathrm{~V}
$$

## Internal Regulator

The regulator powers directly from Vcc and generates a regulated voltage ( $6 \mathrm{~V} @ 40 \mathrm{~mA}$ ). The output is protected for short circuit. This voltage can be used for charge pump circuitry as shown in Figure 1.

## Supply Voltage Under-Voltage Lockout

The under-voltage lockout circuit assures that the MOSFET driver outputs remain in the off state whenever the supply voltage drops below set parameters. Lockout occurs if Vc or Vcc fall below 3.4 V and 4.4 V respectively. Normal operation resumes once Vc and Vcc rise above the set values.

## Shutdown

The converter can be shutdown by pulling the soft-start pin below 0.4 V . The control MOSFET turns off and the synchronous MOSFET turns on during shutdown.

## Over-Current Protection

Over-current protection is achieved with a cycle by cycle scheme and it is performed by sensing current through the Ros(on) of low side MOSFET. As shown in Figure 5, an external resistor (RSET) is connected between OCSet pin and the drain of low side MOSFET (Q2) and sets the current limit set point. The internal current source develops a voltage across Rset. When the low side switch is turned on, the inductor current flows through the Q2 and results a voltage which is given by:

$$
\begin{equation*}
\text { Vocset }=\operatorname{locset~} \times \text { Rset }-R_{d S(O N)} \times \mathrm{iL} \tag{1}
\end{equation*}
$$



Figure 5 - Diagram of the over current sensing.
When voltage Vосset is below zero, the current sensing comparator flips and disables the oscillator. The high side MOSFET is turned off and the low side MOSFET is turned on until the inductor current reduces to below current set value. The critical inductor current can be calculated by setting:

$$
\begin{align*}
& \text { Vocset }=\operatorname{locSET} \times \operatorname{RSET}-\operatorname{RdS}(\mathrm{ON}) \times \operatorname{IL}=0 \\
& \mathrm{ISET}=\operatorname{IL}_{\mathrm{L}(\mathrm{CRITICAL})}=\frac{\operatorname{RSET} \times \operatorname{loCSET}}{\operatorname{RDS}(\mathrm{ON})} \tag{2}
\end{align*}
$$

If the over-current condition is temporary and goes away quickly, the IRU3039 will resume its normal operation.

If output is shorted or over-current condition persists, the output voltage will keep going down until it is below 0.4 V . Then the output under-voltage lock out comparator goes high and turns off both MOSFETs. The operation waveforms are shown in Figure 6.


Figure 6 - Diagram of over-current operation.
Operation in current limit is shown in Figure 7, the high side MOSFET is turned off and inductor current starts to decrease. Because the output inductor current is higher than the current limit setpoint (Iser), the over-current comparator keeps high until the inductor current decreases to be below Iset. Then another cycle starts.

During over-current mode, the valley inductor current is:
iLvalley $=$ Iset
The peak inductor current is given as:

To avoid undesirable trigger of over-current protection, this relationship must be satisfied:

$$
I_{\text {SET }} \geqslant \mathrm{lo}_{\text {(NOM) })}-\frac{\Delta \text { IPK.PK(NOM) }^{2}}{2}
$$



Figure 7 - Operation waveforms during current limit.

From Figure 7, the average inductor current during the current limit mode is:

The inductor's ripple current can be expressed as:

$$
\Delta_{\text {PFK-PK }(L I M)}=\frac{\left(\mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}\right) \times \mathrm{V}_{\text {out }}}{\mathrm{V}_{\text {IN }} \times \mathrm{L} \times \mathrm{fs}}
$$

Combination of above equation and (4) results in:

Combination of equations (5) and (2) results in the relationship between Rset and output current limit.

Where:
lo(LIM) $=$ The Output Current Limit. Typical is $50 \%$ higher than nominal output current
VIN = Maximum Input Voltage
Vout = Output Voltage
$\mathrm{fs}_{\mathrm{S}}=$ Switching Frequency
L = Output Inductor
Ros(on) = Ros(on) of Low Side MOSFET
locset = OC Threshold Set Current

From the above analysis, the current limit is not only dependent on the current setting resistor Rset and Ros(on) of low side MOSFET but it is also dependent on the input voltage, output voltage, inductance and switching frequency as well.

The cycle-by-cycle over-current limit will hold for a certain amount of time, until the output voltage drops below 0.4 V , the under-voltage lock out activates and latches off the output driver. The operation waveform is shown in Figure 7. Normal operation will resume after IRU3039 is powered up again.

## APPLICATION INFORMATION

Design Example:
The following example is a typical application for IRU3039, the schematic is Figure 17 on page 16.

```
\(\mathrm{Vin}=18 \mathrm{~V}\)
Vout \(=3.3 \mathrm{~V}\)
lout \(=8 \mathrm{~A}\)
\(\Delta\) Vout \(=100 \mathrm{mV}\) (output voltage ripple \(\cong 3 \%\) of V оut)
\(\mathrm{fs}_{\mathrm{s}}=200 \mathrm{KHz}\)
```


## Output Voltage Programming

Output voltage is programmed by reference voltage and external voltage divider. The Fb pin is the inverting input of the error amplifier, which is referenced to the voltage on non-inverting pin of error amplifier. For this application, this pin ( $\mathrm{V}_{\mathrm{P}}$ ) is connected to reference voltage ( $\mathrm{V}_{\text {reF }}$ ). The output voltage is defined by using the following equation:

$$
\begin{align*}
& V_{\text {OUT }}=V_{P} \times\left(1+\frac{R_{6}}{R_{5}}\right)  \tag{7}\\
& V_{P}=V_{\text {REF }}=0.8 V
\end{align*}
$$

When an external resistor divider is connected to the output as shown in Figure 8.


Figure 8 - Typical application of the IRU3039 for programming the output voltage.

Equation (7) can be rewritten as:
$R_{6}=R_{5} \times\left(\frac{V_{\text {OUT }}}{V_{P}}-1\right)$
Choose $\mathrm{R}_{5}=1 \mathrm{~K}$
This will result to $\mathrm{R}_{6}=3.16 \mathrm{~K}$
If the high value feedback resistors are used, the input bias current of the Fb pin could cause a slight increase in output voltage. The output voltage set point can be more accurate by using precision resistor.

## Soft-Start Programming

The soft-start timing can be programmed by selecting the soft-start capacitance value. The start-up time of the converter can be calculated by using:

Css $\cong 20 \times$ tstart $\quad(\mu \mathrm{F})$
Where tstart is the desired start-up time (ms)
For a start-up time of 5 ms , the soft-start capacitor will be $0.1 \mu \mathrm{~F}$. Choose a ceramic capacitor at $0.1 \mu \mathrm{~F}$.

## Boost Supply Vc

To drive the high side switch, it is necessary to supply a gate voltage at least 4 V grater than the bus voltage. This is achieved by using a charge pump configuration as shown in Figure 9. This method is simple and inexpensive. The operation of the circuit is as follows: when the lower MOSFET is turned on, the capacitor (C1) is pulled down to ground and charges, up to Voutz value, through the diode (D1). The bus voltage will be added to this voltage when upper MOSFET turns on in next cycle, and providing supply voltage (Vc) through diode (D2). Vc is approximately:

$$
\text { Vc } \cong V_{\text {out } 2}+V_{\text {BUS }}-\left(V_{D 1}+V_{D 2}\right)
$$

Capacitors in the range of $0.1 \mu \mathrm{~F}$ and $1 \mu \mathrm{~F}$ are generally adequate for most applications. The diode must be a fast recovery device to minimize the amount of charge fed back from the charge pump capacitor into Vouta. The diodes need to be able to block the full power rail voltage, which is seen when the high side MOSFET is switched on. For low voltage application, schottky diodes can be used to minimize forward drop across the diodes at start up.


Figure 9 - Charge pump circuit.

## Input Capacitor Selection

The input filter capacitor should be based on how much ripple the supply can tolerate on the DC input line. The ripple current generated during the on time of upper MOSFET should be provided by input capacitor. The RMS value of this ripple is expressed by:
$I_{\text {RMS }}=$ lout $\sqrt{D \times(1-D)}$
Where:
$D$ is the Duty Cycle, $D=V_{\text {out }} / \mathrm{Vin}$.
lrms is the RMS value of the input capacitor current. lout is the output current for each channel.

For $V_{I N}=20 \mathrm{~V}$, lout $=8 \mathrm{~A}$ and $\mathrm{D}=0.165$, the $\mathrm{I}_{\mathrm{Rms}}=3 \mathrm{~A}$
For higher efficiency, a low ESR capacitor is recommended. Choose three Poscap from Sanyo 25TQC15M $(25 \mathrm{~V}, 15 \mu \mathrm{~F}, 90 \mathrm{~m} \Omega)$ with a maximum allowable ripple current of 3 A .

## Inductor Selection

The inductor is selected based on operating frequency, transient performance and allowable output voltage ripple.

Low inductor value results to faster response to step load (high $\Delta i / \Delta t$ ) and smaller size but will cause larger output ripple due to increase of inductor ripple current. As a rule of thumb, select an inductor that produces a ripple current of $10-40 \%$ of full load DC.

For the buck converter, the inductor value for desired operating ripple current can be determined using the following relation:

$$
\begin{align*}
& \text { Vin }-V_{\text {OUT }}=\mathrm{L} \times \frac{\Delta i}{\Delta \mathrm{t}} ; \Delta \mathrm{t}=\mathrm{D} \times \frac{1}{\mathrm{fs}_{\mathrm{S}}} ; \mathrm{D}=\frac{\mathrm{V}_{\text {out }}}{\mathrm{V}_{\text {IN }}} \\
& \mathrm{L}=\left(\mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {OUT }}\right) \times \frac{\text { Vout }^{\mathrm{V}_{\text {IN }} \times \Delta \mathrm{i} \times \mathrm{fs}}}{--(11)} \tag{11}
\end{align*}
$$

Where:
VIN = Maximum Input Voltage
Vout = Output Voltage
$\Delta \mathrm{i}=$ Inductor Ripple Current
fs = Switching Frequency
$\Delta t=$ Turn On Time
D = Duty Cycle
If $\Delta i=37 \%$ (lo), then the output inductor will be:
$\mathrm{L}=4.65 \mu \mathrm{H}$
The Coilcraft DO5022HC series provides a range of inductors in different values, low profile suitable for large currents, $4.7 \mu \mathrm{H}, 13 \mathrm{~A}$ is a good choice for this application. This will result to a ripple approximately $37 \%$ of output current.

## Output Capacitor Selection

The criteria to select the output capacitor is normally based on the value of the Effective Series Resistance (ESR). In general, the output capacitor must have low enough ESR to meet output ripple and load transient
requirements, yet have high enough ESR to satisfy stability requirements. The ESR of the output capacitor is calculated by the following relationship:

$$
\begin{equation*}
\mathrm{ESR} \leq \frac{\Delta \mathrm{V}_{\mathrm{o}}}{\Delta \mathrm{l}_{\mathrm{o}}} \tag{10}
\end{equation*}
$$

Where:
$\Delta \mathrm{V}_{\mathrm{o}}=$ Output Voltage Ripple
$\Delta \mathrm{i}=$ Inductor Ripple Current
$\Delta V_{o}=100 \mathrm{mV}$ and $\Delta I \cong 40 \%$ of $8 \mathrm{~A}=3.2 \mathrm{~A}$
This results to: $\mathrm{ESR}=31 \mathrm{~m} \Omega$
The Sanyo TPC series, Poscap capacitor is a good choice. The 6TPC330M, $330 \mu \mathrm{~F}, 6.3 \mathrm{~V}$ has an ESR $40 \mathrm{~m} \Omega$. Selecting two of these capacitors in parallel, results to an ESR of $\cong 20 \mathrm{~m} \Omega$ which achieves our low ESR goal.

The capacitor value must be high enough to absorb the inductor's ripple current. The larger the value of capacitor, the lower will be the output ripple voltage.

## Power MOSFET Selection

The IRU3039 uses two N-Channel MOSFETs. The selections criteria to meet power transfer requirements is based on maximum drain-source voltage (VDss), gatesource drive voltage (VGs), maximum output current, Onresistance $\mathrm{Ros}_{\mathrm{D}(\mathrm{ON})}$ and thermal management.

The MOSFET must have a maximum operating voltage (Voss) exceeding the maximum input voltage ( V IN).

The gate drive requirement is almost the same for both MOSFETs. Logic-level transistor can be used and caution should be taken with devices at very low Vas to prevent undesired turn-on of the complementary MOSFET, which results a shoot-through current.

The total power dissipation for MOSFETs includes conduction and switching losses. For the Buck converter, the average inductor current is equal to the DC load current. The conduction loss is defined as:

$$
\begin{aligned}
& \operatorname{Pcond}\left(\text { Upper Switch) }=\ell_{\text {LOAD }}^{2} \times \operatorname{RDS}(O N) \times \mathrm{D} \times \vartheta\right. \\
& \operatorname{Pcond}(\text { Lower } S w i t c h)=I_{\text {LOAD }}^{2} \times \operatorname{RDS}(O N) \times(1-\mathrm{D}) \times \vartheta \\
& \vartheta=\operatorname{RDS}(O N) \text { Temperature Dependency }
\end{aligned}
$$

The Rds(on) temperature dependency should be considered for the worst case operation. This is typically given in the MOSFET data sheet. Ensure that the conduction losses and switching losses do not exceed the package ratings or violate the overall thermal budget.

Choose IRF7466 for control MOSFET and IRF7458 for synchronous MOSFET. These devices provide low onresistance in a compact SOIC 8-Pin package.

The MOSFETs have the following data:

IRF7466
Voss $=30 \mathrm{~V}$
$\mathrm{lD}=11 \mathrm{~A}$
$\operatorname{RDS}_{\mathrm{DS}}(\mathrm{ON})=12.5 \mathrm{~m} \Omega$

IRF7458
Voss $=30 \mathrm{~V}$
$\mathrm{ld}=14 \mathrm{~A}$
$\operatorname{Rds}(\mathrm{ON})=8 \mathrm{~m} \Omega$

The total conduction losses will be:

```
Pcon(total) \(=\mathrm{Pcon}\) (upper) +Pcon (Lower)
\(\mathrm{Pcon}_{\text {(total }}=0.85 \mathrm{~W}\)
```

The switching loss is more difficult to calculate, even though the switching transition is well understood. The reason is the effect of the parasitic components and switching times during the switching procedures such as turn-on / turnoff delays and rise and fall times. The control MOSFET contributes to the majority of the switching losses in synchronous Buck converter. The synchronous MOSFET turns on under zero voltage conditions, therefore, the turn on losses for synchronous MOSFET can be neglected. With a linear approximation, the total switching loss can be expressed as:
$\mathrm{Psw}_{\mathrm{SW}}=\frac{\mathrm{V}_{\text {DS(OFF) }}}{2} \times \frac{\mathrm{tr}+\mathrm{tf}}{\mathrm{T}} \times \operatorname{l\text {LOAD}}$
Where:
Vos(Off) $=$ Drain to Source Voltage at off time
tr = Rise Time
tf = Fall Time
T = Switching Period
Lload = Load Current
The switching time waveform is shown in Figure 10.


Figure 10-Switching time waveforms.
From IRF7466 data sheet we obtain:
IRF7466
$\mathrm{tr}=2.8 \mathrm{~ns}$
$\mathrm{tf}=3.6 \mathrm{~ns}$

These values are taken under a certain condition test. For more details please refer to the IRF7466 and IRF7458 data sheets.

By using equation (12), we can calculate the total switching losses.

$$
\mathrm{Psw}_{\text {(TOTAL }}=92 \mathrm{~mW}
$$

## Programming the Over-Current Limit

The over-current threshold can be set by connecting a resistor (Rset) from drain of low side MOSFET to the OCSet pin. The resistor can be calculated by using equation (2).

The Ros(on) has a positive temperature coefficient and it should be considered for the worse case operation.

$$
\begin{aligned}
& \operatorname{RDS}(O N)=8 \mathrm{~m} \Omega \times 1.5=12 \mathrm{~m} \Omega \\
& \mathrm{ISET} \cong \mathrm{lo}(\mathrm{LIM})=8 \mathrm{~A} \times 1.5=12 \mathrm{~A}
\end{aligned}
$$

(50\% over nominal output current)

$$
\begin{aligned}
& \text { This results to: } \\
& \text { Rset }=5.76 \mathrm{~K} \Omega
\end{aligned}
$$

## Feedback Compensation

The IRU3039 is a voltage mode controller; the control loop is a single voltage feedback path including error amplifier and error comparator. To achieve fast transient response and accurate output regulation, a compensation circuit is necessary. The goal of the compensation network is to provide a closed loop transfer function with the highest 0 dB crossing frequency and adequate phase margin (greater than $45^{\circ}$ ).

The output LC filter introduces a double pole, $-40 \mathrm{~dB} /$ decade gain slope above its corner resonant frequency, and a total phase lag of $180^{\circ}$ (see Figure 11). The Resonant frequency of the LC filter is expressed as follows:

$$
\begin{equation*}
\mathrm{FLC}_{\mathrm{LC}}=\frac{1}{2 \pi \times \sqrt{\mathrm{Lo} \times \mathrm{Co}}} \tag{13}
\end{equation*}
$$

Figure 11 shows gain and phase of the LC filter. Since we already have $180^{\circ}$ phase shift just from the output filter, the system risks being unstable.



Figure 11-Gain and phase of LC filter.

The IRU3039's error amplifier is a differential-input transconductance amplifier. The output is available for DC gain control or AC phase compensation.

The E/A can be compensated with or without the use of local feedback. When operated without local feedback, the transconductance properties of the E/A become evident and can be used to cancel one of the output filter poles. This will be accomplished with a series RC circuit from Comp pin to ground as shown in Figure 12.

Note that this method requires that the output capacitor should have enough ESR to satisfy stability requirements. In general, the output capacitor's ESR generates a zero typically at 5 KHz to 50 KHz which is essential for an acceptable phase margin.

The ESR zero of the output capacitor expressed as follows:

$$
\begin{equation*}
\mathrm{F}_{\mathrm{ESR}}=\frac{1}{2 \pi \times \mathrm{ESR} \times \mathrm{Co}} \tag{14}
\end{equation*}
$$



Figure 12 - Compensation network without local feedback and its asymptotic gain plot.

The transfer function (Ve / Vout) is given by:

$$
\begin{equation*}
H(s)=\left(g_{m} \times \frac{R_{5}}{R_{6}+R_{5}}\right) \times \frac{1+s R_{4} C_{9}}{s C_{9}} \tag{15}
\end{equation*}
$$

The (s) indicates that the transfer function varies as a function of frequency. This configuration introduces a gain and zero, expressed by:

$$
\begin{align*}
& \left|H\left(s=j \times 2 \pi \times F_{o}\right)\right|=g_{m} \times \frac{R_{5}}{R_{6} \times R_{5}} \times R_{4}  \tag{16}\\
& F_{z}=\frac{1}{2 \pi \times R_{4} \times C_{9}} \quad---(17) \tag{17}
\end{align*}
$$

$|\mathrm{H}(\mathrm{s})|$ is the gain at zero cross frequency.

First select the desired zero-crossover frequency (Fo):

$$
\text { Fo }>F_{\text {ESR }} \text { and } F_{o} \leq(1 / 5 \sim 1 / 10) \times \text { fs }
$$

Use the following equation to calculate $\mathrm{R}_{4}$ :

$$
\begin{equation*}
R_{4}=\frac{V_{\text {OSC }}}{V_{\text {IN }}} \times \frac{F_{O} \times F_{\text {ESR }}}{F_{\text {LC }}} \times \frac{R_{5}+R_{6}}{R_{5}} \times \frac{1}{g_{m}} \tag{18}
\end{equation*}
$$

Where:
VIN = Maximum Input Voltage
Vosc = Oscillator Ramp Voltage
Fo = Crossover Frequency
FESR $=$ Zero Frequency of the Output Capacitor
FLC = Resonant Frequency of the Output Filter
$R_{5}$ and $R_{6}=$ Resistor Dividers for Output Voltage Programming
$\mathrm{g}_{\mathrm{m}}=$ Error Amplifier Transconductance
For:

| $\mathrm{V}_{\mathrm{IN}}=18 \mathrm{~V}$ | $\mathrm{~F}_{\text {LC }}=2.8 \mathrm{KHz}$ |
| :--- | :--- |
| $\mathrm{V}_{\text {osc }}=3.3 \mathrm{~V}$ | $\mathrm{R}_{5}=1 \mathrm{~K}$ |
| $\mathrm{Fo}_{\mathrm{K}}=20 \mathrm{KHz}$ | $\mathrm{R}_{6}=3.16 \mathrm{~K}$ |
| $\mathrm{~F}_{\text {ESR }}=12 \mathrm{KHz}$ | $\mathrm{g}_{\mathrm{m}}=700 \mu \mathrm{mho}$ |

This results to $\mathrm{R}_{4}=12.08 \mathrm{~K}$ Choose $\mathrm{R}_{4}=14 \mathrm{~K}$

To cancel one of the LC filter poles, place the zero before the LC filter resonant frequency pole:

$$
\begin{align*}
& \mathrm{Fz} \cong 75 \% \mathrm{FLC} \\
& \mathrm{Fz} \cong 0.75 \times \frac{1}{2 \pi \sqrt{\mathrm{Lo} \times \mathrm{Co}}} \tag{19}
\end{align*}
$$

For:

$$
\begin{array}{ll}
\mathrm{Lo}=4.7 \mu \mathrm{H} & \mathrm{Fz}=2.1 \mathrm{KHz} \\
\mathrm{Co}=660 \mu \mathrm{~F} & \mathrm{R} 4=14 \mathrm{~K}
\end{array}
$$

Using equations (17) and (19) to calculate Ce, we get:

$$
\mathrm{C}_{9} \cong 5300 \mathrm{pF} ; \text { Choose } \mathrm{C}_{9}=5600 \mathrm{pF}
$$

One more capacitor is sometimes added in parallel with $\mathrm{C}_{9}$ and $\mathrm{R}_{4}$. This introduces one more pole which is mainly used to suppress the switching noise. The additional pole is given by:

$$
F_{P}=\frac{1}{2 \pi \times R_{4} \times \frac{C_{9} \times \text { CPOLE }}{C_{9}+\text { CpoLE }}}
$$

The pole sets to one half of switching frequency which results in the capacitor Cpole:

$$
\begin{aligned}
& \text { CPOLE }=\frac{1}{\pi \times R_{4} \times f_{s}-\frac{1}{C_{9}}} \cong \frac{1}{\pi \times R_{4} \times f_{s}} \\
& \text { for } F_{P} \ll \frac{f_{s}}{2}
\end{aligned}
$$

For a general solution for unconditionally stability for ceramic capacitor with very low ESR and any type of output capacitors, in a wide range of ESR values we should implement local feedback with a compensation network. The typically used compensation network for voltage-mode controller is shown in Figure 13.



Figure 13 - Compensation network with local feedback and its asymptotic gain plot.

In such configuration, the transfer function is given by:

$$
\frac{V_{e}}{V_{\text {out }}}=\frac{1-g_{m} Z_{i}}{1+g_{m} Z_{N}}
$$

The error amplifier gain is independent of the transconductance under the following condition:

$$
\begin{equation*}
g_{m} Z_{r} \gg 1 \quad \text { and } \quad g_{m} Z_{N} \gg 1 \tag{20}
\end{equation*}
$$

By replacing $\mathrm{Z}_{\mathrm{N}}$ and $\mathrm{Z}_{\text {e according }}$ to Figure 9, the transformer function can be expressed as:
$H(s)=\frac{1}{s R_{6}\left(\mathrm{C}_{12}+\mathrm{C}_{11}\right)} \times \frac{\left(1+\mathrm{sR}_{7} \mathrm{C}_{11}\right) \times\left[1+\mathrm{sC}_{10}\left(\mathrm{R}_{6}+\mathrm{R}_{8}\right)\right]}{\left[1+\mathrm{sR}_{7}\left(\frac{\mathrm{C}_{12} \mathrm{C}_{11}}{\mathrm{C}_{12}+\mathrm{C}_{11}}\right)\right] \times\left(1+\mathrm{sR}_{8} \mathrm{C}_{10}\right)}$
As known, transconductance amplifier has high impedance (current source) output, therefore, consider should be taken when loading the E/A output. It may exceed its source/sink output current capability, so that the amplifier will not be able to swing its output voltage over the necessary range.

The compensation network has three poles and two zeros and they are expressed as follows:
$\mathrm{F}_{\mathrm{P} 1}=0$
$\mathrm{FP}_{\mathrm{P} 2}=\frac{1}{2 \pi \times \mathrm{R}_{8} \times \mathrm{C}_{10}}$
$F_{P 3}=\frac{1}{2 \pi \times R_{7} \times\left(\frac{C_{12} \times C_{11}}{C_{12}+C_{11}}\right)} \cong \frac{1}{2 \pi \times R_{7} \times C_{12}}$
$\mathrm{F}_{\mathrm{z} 1}=\frac{1}{2 \pi \times \mathrm{R}_{7} \times \mathrm{C}_{11}}$
$\mathrm{F}_{\mathrm{z} 2}=\frac{1}{2 \pi \times \mathrm{C}_{10} \times\left(\mathrm{R}_{6}+\mathrm{R}_{8}\right)} \cong \frac{1}{2 \pi \times \mathrm{C}_{10} \times \mathrm{R}_{6}}$
Cross Over Frequency:
$\mathrm{Fo}_{\mathrm{O}}=\mathrm{R}_{7} \times \mathrm{C}_{10} \times \frac{\mathrm{V}_{\text {IN }}}{\mathrm{V}_{\text {osc }}} \times \frac{1}{2 \pi \times \mathrm{LO} \times \mathrm{Co}_{0}}$
Where:
Vin = Maximum Input Voltage
Vosc = Oscillator Ramp Voltage
Lo $=$ Output Inductor
Co $=$ Total Output Capacitors
The stability requirement will be satisfied by placing the poles and zeros of the compensation network according to following design rules. The consideration has been taken to satisfy condition (20) regarding transconductance error amplifier.

These design rules will give a crossover frequency approximately one-tenth of the switching frequency. The higher the band width, the potentially faster the load transient speed. The gain margin will be large enough to provide high DC-regulation accuracy (typically -5dB to 12dB). The phase margin should be greater than $45^{\circ}$ for overall stability.

Based on the frequency of the zero generated by ESR versus crossover frequency, the compensation type can be different. The table below shows the compensation type and location of crossover frequency.

| Compensator <br> Type | Location of Zero <br> Crossover Frequency <br> (Fo) | Typical <br> Output <br> Capacitor |
| :--- | :---: | :---: |
| Type II (PI) | FPo $<$ Fzo $<$ Fo $<\mathrm{fs} / 2$ | Electrolytic, <br> Tantalum |
| Type III (PID) <br> Method A | FPO $<$ Fo $<$ Fzo $<\mathrm{fs} / 2$ | Tantalum, <br> Ceramic |
| Type III (PID) <br> Method B | FPO $<$ Fo $<\mathrm{Fs} / 2<$ Fzo | Ceramic |
| Table - The compensation type and location of zero |  |  |
| crossover frequency. |  |  |

Detail information is dicussed in application Note AN1043 which can be downloaded from the IR Web-Site.

## Layout Consideration

The layout is very important when designing high frequency switching converters. Layout will affect noise pickup and can cause a good design to perform with less than expected results.

Start to place the power components. Make all the connections in the top layer with wide, copper filled areas. The inductor, output capacitor and the MOSFET should be close to each other as possible. This helps to reduce the EMI radiated by the power traces due to the high switching currents through them. Place input capacitor directly to the drain of the high-side MOSFET. To reduce
the ESR, replace the single input capacitor with two parallel units. The feedback part of the system should be kept away from the inductor and other noise sources and be placed close to the IC. In multilayer PCB, use one layer as power ground plane and have a separate control circuit ground (analog ground), to which all signals are referenced. The goal is to localize the high current path to a separate loop that does not interfere with the more sensitive analog control function. These two grounds must be connected together on the PC board layout at a single point.


Figure 14 - Switching Frequency versus Resistor.


Figure 15 - Typical application of the IRU3039 with two input supplies.

TYPICAL APPLICATION


Figure 16 - Typical application of IRU3039 for DDR memory when IRU3039 generates $\mathrm{V}_{\text {core }}$ and IRU3038 generates the termination voltage.

## DEMO-BOARD APPLICATION

18 V to $3.3 \mathrm{~V} @ 8 \mathrm{~A}$


Figure 17 - Demo-board application of the IRU3039.
PARTS LIST

| Ref Desig | Description | Value | Qty | Part\# | Manuf | Web site (www.) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Q1 | MOSFET | $30 \mathrm{~V}, 12.5 \mathrm{~m} \Omega$, 11A | 1 | IRF7466 | IR | irf.com |
| Q2 | MOSFET | $30 \mathrm{~V}, 8 \mathrm{~m} \Omega$, 14A | 1 | IRF7458 | IR |  |
| U1 | Controller | Synchronous PWM | 1 | IRU3039 | IR |  |
| D1 | Schottky Diode | Fast Switching | 1 | BAT54S | IR |  |
| D2 | Schottky Diode | Fast Switching | 1 | BAT54 | IR |  |
| L1 | Inductor | $1 \mu \mathrm{H}, 3 \mathrm{~A}$ | 1 | DS1608C-102 | Coilcraft | coilcraft.com |
| L2 | Inductor | $4.7 \mu \mathrm{H}, 13 \mathrm{~A}$ | 1 | DO5022P-472HC | Coilcraft |  |
| C1,C2A,B,C | Cap, Poscap | $15 \mu \mathrm{~F}, 25 \mathrm{~V}$ | 4 | 25TQC15M | Sanyo | sanyo.com |
| C5,6,10 | Capacitor |  | 3 | ECJ-2VF1E104Z | Panasonic | maco.panasonic.co.jp |
| C7 | Capacitor | 5600pF, X7R, 50V | 1 | ECU-V1H562KBG | Panasonic |  |
| C8 | Capacitor | 470pF, X7R, 50V | 1 | ECJ-2VC1H471J | Panasonic |  |
| C9A,B | Capacitor | 330uF, $40 \mathrm{~m} \Omega$ | 2 | 6TPB-330M | Sanyo | sanyo.com |
| C3,11,12 | Capacitor | $1 \mu \mathrm{~F}, \mathrm{Y} 5 \mathrm{~V}, 16 \mathrm{~V}$ | 3 | ECJ-2VF1C105Z | Panasonic | maco.panasonic.co.jp |
| C13 | Capacitor | $1 \mu \mathrm{~F}, \mathrm{X} 7 \mathrm{R}, 25 \mathrm{~V}$ | 1 | ECJ-3YB1E105K | Panasonic |  |
| R4 | Resistor | 5.76K | 1 |  |  |  |
| R7 | Resistor | 14 K | 1 |  |  |  |
| R8 | Resistor | $4.7 \Omega$ | 1 |  |  |  |
| R9 | Resistor | 3.16K | , |  |  |  |
| R10 | Resistor | 1K | 1 |  |  |  |

## TYPICAL OPERATING CHARACTERISTICS

## Test Conditions:

Vin=20V, Vout=3.3V, lout=0-8A, Fs=200KHz


Figure 18 - Normal condition at No Load. Ch1: HDrv, Ch2: LDrv, Ch4: Inductor Current


Figure 19-Soft-Start pin grounded. Ch1: HDrv, Ch2: LDrv


Figure 20 - Soft-Start.
Ch1: Vin, Ch2: Vout, Ch3: Voutz, Ch4: Vss


Figure 21 - Output Ripple.
Ch1: Output Ripple, Ch2: HDrv, Ch3: LDrv, Ch4: Inductor Current

## TYPICAL OPERATING CHARACTERISTICS

Test Conditions:
$\mathrm{V}_{\mathrm{In}}=20 \mathrm{~V}$, Vout=3.3V, lout=0-8A, Fs=200KHz


Figure 22 - Output shorted at start up. Ch1: Vout, Ch3: Vss, Ch4: Inductor Current


Figure 23 - Load Transient Response Ch1: Vout, Ch3: Output Current


Figure 24 - Efficiency Measurement.
Vin=20V, Vout=3.3V

## TYPICAL PERFORMANCE CHARACTERISTICS

For all charts: $\mathrm{VC}=\mathrm{VCC}=12 \mathrm{~V}, 20 \mathrm{~V}$, 24 V
Note: Data are taken with few samples to indicate the variation of these parameters over the wide temperature range.


Figure 25 - Vref vs.Temperature


Figure 26 - Frequency vs.Temperature $\mathrm{Fs}=200 \mathrm{KHz}$


Figure 27 - Deadtime, Control FET Drive Rising Time vs.Temperature $\mathrm{Fs}=400 \mathrm{KHz}, \mathrm{Cload}=3300 \mathrm{pF}$


Figure 28 - Vouta vs.Temperature


Figure 29 - Frequency vs.Temperature $\mathrm{Fs}=400 \mathrm{KHz}$


Figure 30 - Deadtime, Sync FET Drive
Rising Time vs.Temperature
$F s=400 \mathrm{KHz}, \mathrm{Cload}=3300 \mathrm{pF}$

## TYPICAL PERFORMANCE CHARACTERISTICS

For all charts: VC=VCC=12V, 20V, 24V
Note: Data are taken with few samples to indicate the variation of these parameters over the wide temperature range.


Figure 31 - Control FET Drive Rise Time vs.Temp. $F s=400 \mathrm{KHz}$, Cload $=3300 \mathrm{pF}$


Figure 33 - Control FET Drive Fall Time vs.Temp. $F_{s}=400 \mathrm{KHz}$, Cload $^{2}=3300 \mathrm{pF}$


Figure 34 - Sync FET Drive Fall Time vs.Temp. $F_{s}=400 \mathrm{KHz}, \mathrm{Cload}^{2}=3300 \mathrm{pF}$

## International <br> IOR Rectifier

(H) MLPQ 5x5 Package 20-Pin


BOTTOM VIEW


Note 1: Details of pin \#1 are optional, but must be located within the zone indicated. The identifier may be molded, or marked features.

| SYMBOL <br> DESIG | 20-PIN 5x5 |  |  |
| :---: | :---: | :---: | :---: |
|  | NOM | MAX |  |
| A | 0.80 | 0.90 | 1.00 |
| A1 | 0.00 | 0.02 | 0.05 |
| A3 | 0.20 REF |  |  |
| B | 0.23 | 0.30 | 0.38 |
| D | 5.00 BSC |  |  |
| D2 | 3.00 | 3.15 | 3.25 |
| E | 5.00 BSC |  |  |
| E2 | 3.00 | 3.15 | 3.25 |
| e | 0.65 BSC |  |  |
| L | 0.45 | 0.55 | 0.65 |
| R | 0.115 | --- | --- |

NOTE: ALL MEASUREMENTS
ARE IN MILLIMETERS.

## PACKAGE SHIPMENT METHOD

| PKG <br> DESIG | PACKAGE <br> DESCRIPTION | PIN <br> COUNT | PARTS <br> PER TUBE | PARTS <br> PER REEL | T \& R <br> Orientation |
| :---: | :---: | :---: | :---: | :---: | :---: |
| H | MLPQ $5 \times 5$ | 20 | -- | 3000 | Fig A |



Feed Direction
Figure A - Live Bug

